PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Rajendra Narayanrao Kankan	10/13/2011
Dharmaraj Ramachandra Rao	10/13/2011
Dilip Ramdas Birari	10/13/2011

RECEIVING PARTY DATA

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City:	Mumbai
State/Country:	INDIA
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13254649

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ATTORNEY DOCKET NUMBER: EEHC/27780US (4137-10900)

NAME OF SUBMITTER: Rodney B. Carroll

Total Attachments: 3

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13254649

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PATENT REEL: 027118 FRAME: 0017

ASSIGNMENT

WHEREAS, I, among the following inventors, Rajendra Narayanrao KANKAN, Dharmaraj Ramachandra RAO, and Dilip Ramdas BIRARI, am an inventor of PROCESS FOR THE PREPARATION OF CINACALCET AND SALTS THEREOF, AND INTERMEDIATES FOR USE IN THE PROCESS (the "Invention"), and of an application for United States Patent disclosing said invention, Serial No. 13/254,649, filed September 2, 2011, also known as attorney docket number EEHC/27780 US (4137-10900); and

WHEREAS, CIPLA LIMITED, a corporation created and existing under and by virtue of the laws of India, is desirous of acquiring the entire right, title and interest in and to the aforesaid Invention throughout the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, transfer and set over to CIPLA LIMITED, all right, title and interest in and to the said Invention throughout the world, and said application for U.S. Letters Patent, and any and all other applications for said Invention, including divisional, continuation, provisional, non-provisional, regular, and reissue applications, and any and all Letters Patent of the United States and foreign countries which may be granted therefor, the same to be held and enjoyed by CIPLA LIMITED for its own use and benefit, and for the use and benefit of its successors, assigns, or other legal representatives, to the end of the term or terms for which said Letters Patent of the United States or foreign countries are or may be granted or reissued, as fully and entirely as the same would have been held and enjoyed if this assignment and sale had not been made.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said Invention or resulting from said application and from any and all divisions, continuations, and reissues thereof, to CIPLA LIMITED, as assignee of my entire interest, and hereby covenant that I have the full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith.

And I further hereby covenant and agree that I will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title of said invention and to such Letters Patent as may be granted therefor, to CIPLA LIMITED, its successors, assigns, or other legal representatives and that if CIPLA LIMITED, its successors, assigns or other legal representatives shall desire to file any divisional or continuation applications or to secure a reissue of such Letters Patent, or to file a disclaimer relating thereto, I will upon request, sign all papers, make all rightful oaths and do all lawful acts requisite for the filing of such divisional or continuation application, or such application for reissue and the procuring thereof, and for the filing of such disclaimer, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

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And I do further covenant and agree that I will, at any time upon request, communicate to CIPLA LIMITED, its successors, assigns or other legal representatives, such facts relating to said Invention and Letters Patent or the file history thereof as may be known to me, and testify as to the same in any interference or other litigation when requested so to do, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

ASSIGNOR:	•	
Date: 13 · 10 · 2011	Signature:	Rajendra Narayanrao KANKAN
WITNESS:		
Date:13.10.2011	Signature: Name:	Valishali Haldavanska
ASSIGNOR:		
Date: 13 10 2011	Signature:	Dharmaraj Ramachandra RAO
WITNESS:		
Date: 13/10/2011	Signature:	Darna
	Name:	Disti C Sharma

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ASSIGNOR:		
Date: 13.10.2011	Signature:	Line,
		Dilip Ramdas BIRARI
WITNESS:		
Date: 13 · [0 · 20]]	Signature:	Youle
	0.9.14.0.70.	4. 4
	Name:	Madhua Bhide

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RECORDED: 10/25/2011

PATENT REEL: 027118 FRAME: 0020